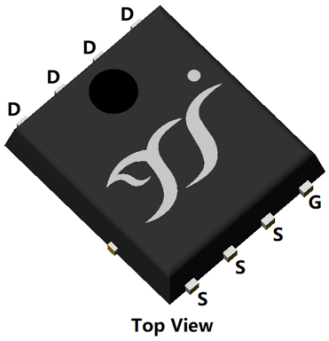
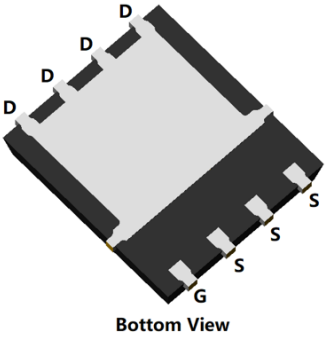
RoHS COMPLIANT

N-Channel Enhancement Mode Field Effect Transistor

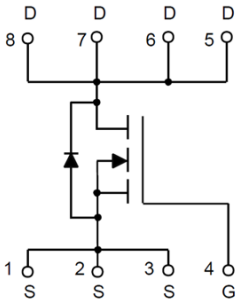


Top View



Bottom View

PDFN5060-8L



Product Summary

- V_{DS} 30V
- I_D 40A
- $R_{DS(ON)}$(at V_{GS}=10V) ＜7.5mohm
- $R_{DS(ON)}$(at V_{GS}=4.5V) ＜11.5mohm
- 100% EAS Tested
- 100% ▽V_{DS} Tested

General Description

- Trench Power LV MOSFET technology
- Excellent package for heat dissipation
- High density cell design for low $R_{DS(ON)}$
- Moisture Sensitivity Level 1
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free

Applications

- High current load applications
- Load switching
- Hard switched and high frequency circuits
- Uninterruptible power supply

■ Absolute Maximum Ratings (T_A=25℃unless otherwise noted)

Parameter		Symbol	Limit	Unit
Drain-source Voltage		V_{DS}	30	V
Gate-source Voltage		V_{GS}	±20	V
Drain Current	T_C=25℃	I_D	40	A
	T_C=100℃		25	
Pulsed Drain Current [A]		I_{DM}	140	A
Total Power Dissipation	T_C=25℃	P_D	21	W
	T_C=100℃		8.4	W
Total Power Dissipation	T_A= =25℃	P_D	5	W
Single Pulse Avalanche Energy [B]		E_{AS}	56	mJ
Thermal Resistance Junction-to-Case [C]		$R_{\theta JC}$	6	℃/ W
Thermal Resistance Junction-to-Ambient [C]		$R_{\theta JA}$	25	℃/ W
Junction and Storage Temperature Range		T_J ,T_{STG}	-55～+150	℃

■ Ordering Information (Example)

PREFERED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
YJG40N03A	F1	YJG40N03A	5000	10000	100000	13“ reel

■ Electrical Characteristics (T_J=25℃ unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}= 0V, I_D=250μA	30			V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=30V,V_{GS}=0V			1	μA
Gate-Body Leakage Current	I_{GSS}	V_{GS}= ±20V, V_{DS}=0V			±100	nA
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}= V_{GS}, I_D=250μA	1.0	1.5	2.5	V
Static Drain-Source On-Resistance	$R_{DS(ON)}$	V_{GS}= 10V, I_D=15A		5.5	7.5	mΩ
		V_{GS}= 4.5V, I_D=15A		9.5	11.5	
Diode Forward Voltage	V_{SD}	I_S=15A,V_{GS}=0V		0.85	1.2	V
Gate resistance	R_G	f=1MHz	-	1.8	-	Ω
Maximum Body-Diode Continuous Current	I_S				40	A
Dynamic Parameters						
Input Capacitance	C_{iss}	V_{DS}=15V,V_{GS}=0V,f=1MHZ		1015		pF
Output Capacitance	C_{oss}			201		
Reverse Transfer Capacitance	C_{rss}			164		
Gate resistance	Rg	f=1MHz		2.0		Ω
Switching Parameters						
Total Gate Charge	Q_g	V_{GS}=10V,V_{DS}=15V,I_D=15A		23.6		nC
Gate-Source Charge	Q_{gs}			3.9		
Gate-Drain Charge	Q_{gd}			7		
Reverse Recovery Charge	Q_{rr}	I_F=25A, di/dt=100A/us		0.2		
Reverse Recovery Time	t_{rr}			5		ns
Turn-on Delay Time	$t_{D(on)}$	V_{GS}=10V,V_{DD}=20V, I_D=2A,R_L=1Ω R_{GEN}=3Ω		7		
Turn-on Rise Time	t_r			19		
Turn-off Delay Time	$t_{D(off)}$			24		
Turn-off fall Time	t_f			24		

A. Pulse Test: Pulse Width≤300us,Duty cycle ≤2%.

B. T_J=25℃, V_{DD}=20V, V_G=10V, L=0.5mH, R_g=25Ω, IAS=15A

C. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design, while $R_{\theta JA}$ is determined by the board design. The maximum rating presented here is based on mounting on a 1 in 2 pad of 2oz copper.

■ Typical Performance Characteristics

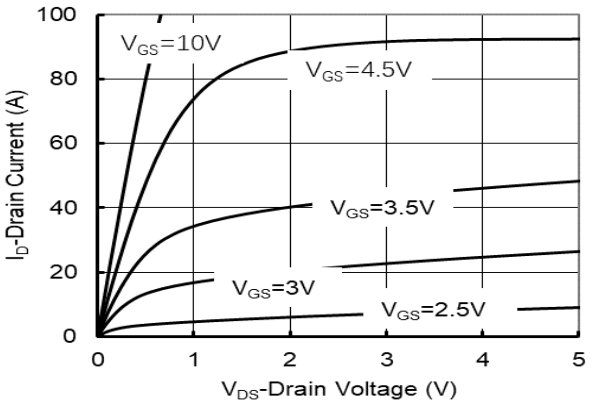


Figure1. Output Characteristics

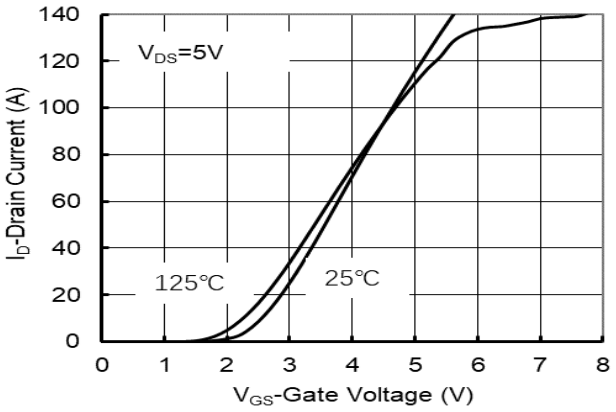


Figure2. Transfer Characteristics

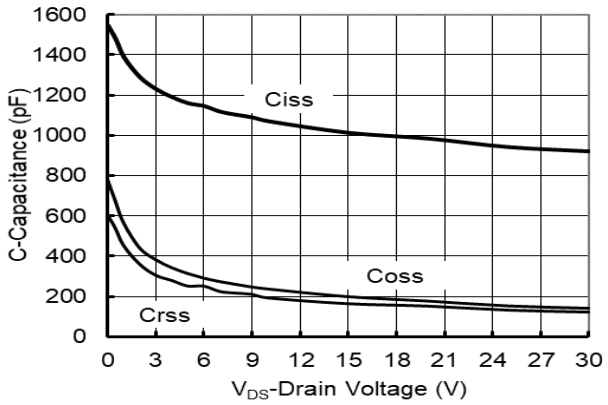


Figure3. Capacitance Characteristics

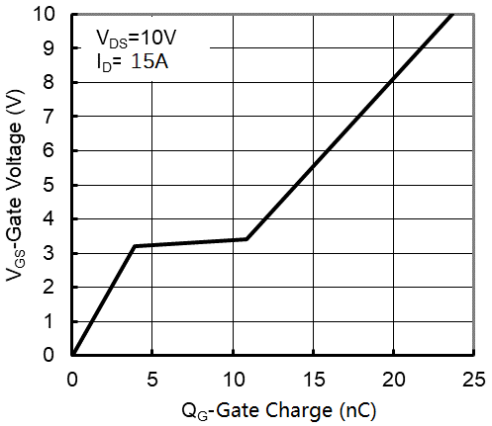


Figure4. Gate Charge

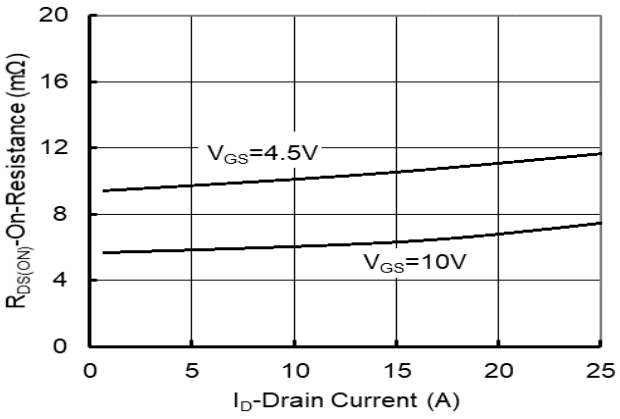


Figure5. Drain-Source on Resistance

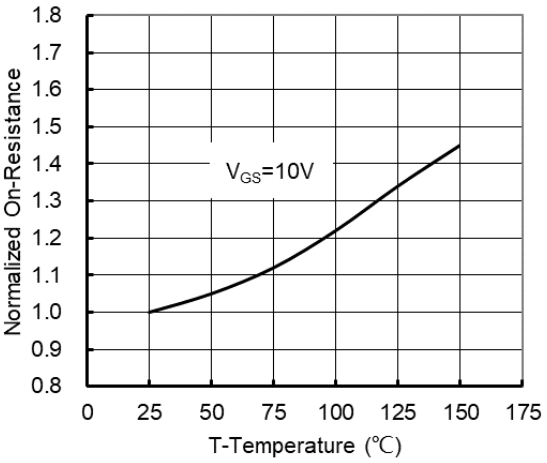


Figure6. Drain-Source on Resistance

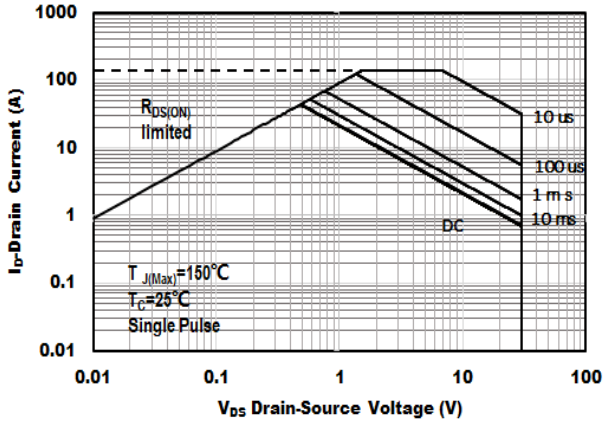


Figure7. Safe Operation Area

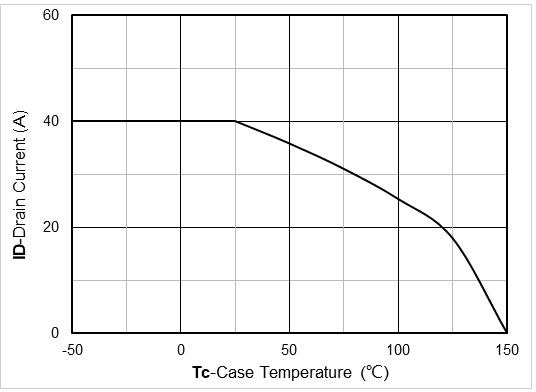


Figure8. Drain current vs. Case Temperature

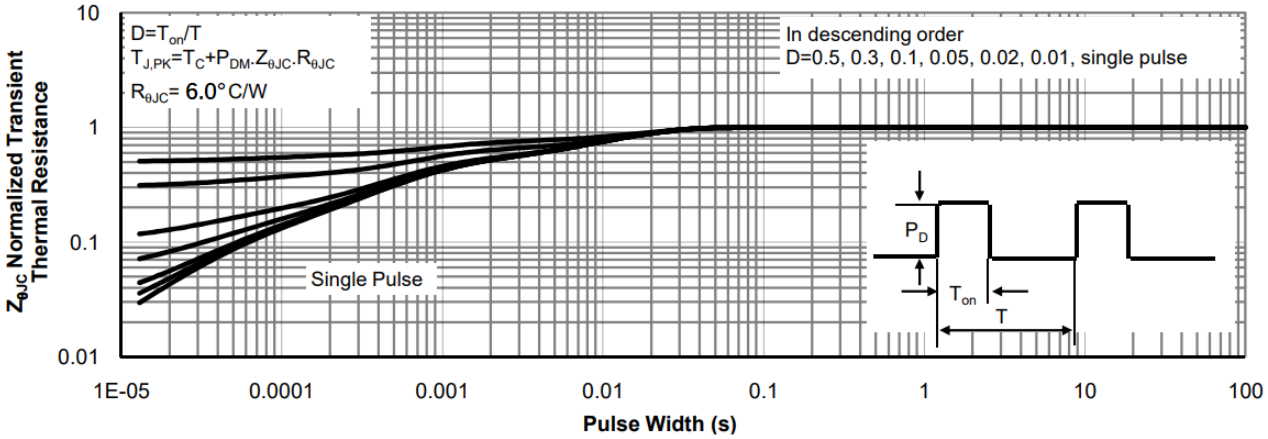
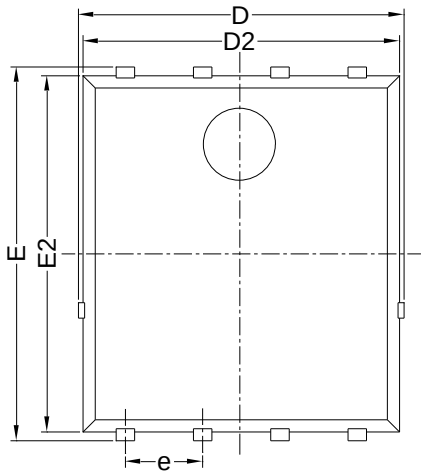
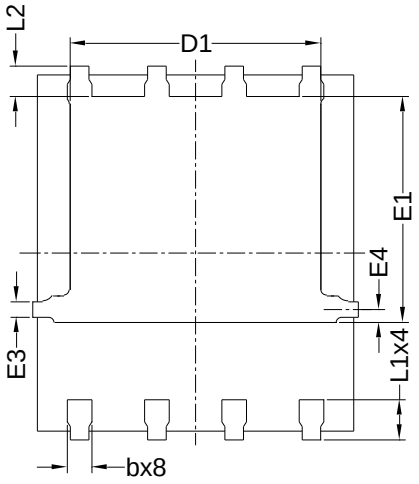


Figure 9. Normalized Maximum Transient Thermal Impedance

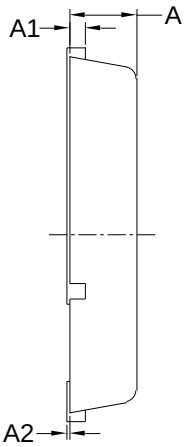
■ PDFN5060-8L-B-1.1MM Package Information



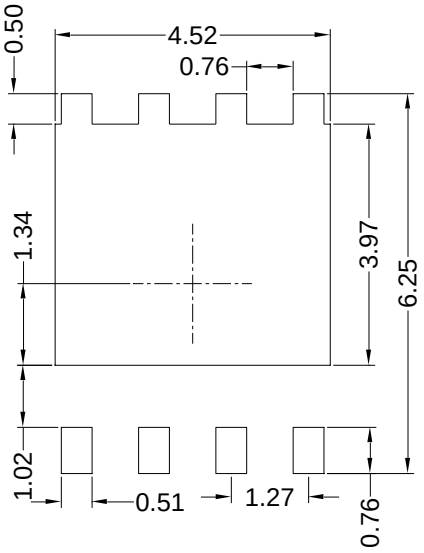
Top View
正面视图



Bottom View
背面视图



Side View
侧面视图



Suggested Solder Pad Layout
Top View

SYMBOL	MILLIMETER		
	MIN	NOM	MAX
D	5.15	5.35	5.55
E	5.95	6.15	6.35
A	1.00	1.10	1.20
A1		0.254 BSC	
A2			0.10
D1	3.92	4.12	4.32
E1	3.52	3.72	3.92
D2	5.00	5.20	5.40
E2	5.66	5.86	6.06
E3		0.254 REF	
E4		0.21 REF	
L1	0.56	0.66	0.76
L2		0.50 BSC	
b	0.31	0.41	0.51
e		1.27 BSC	

Note:
1.Controlling dimension:in millimeters.
2.General tolerance:±0.10mm.
3.The pad layout is for reference purposes only.

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